

20. August 2021

PCN Änderung der Verpackung von B82732F Rahmenkern- drosseln

Um die Verpackung von EPCOS Rahmenkerndrosseln zu standardisieren und die Stabilität während des Transports zu erhöhen, wird die Verpackung von Polystyrol- auf Blisterschalen umgestellt. Dabei vergrößern sich die Verpackungseinheiten (VE) und die Mindestbestellmengen (MBM) werden entsprechend angepasst.

Betroffene Produkte

Bestellnummer
B82732F*

Vergleich neue und bisherige Verpackung

Bestellnummer	Vorherige	Neu
B82732F*	Styroporschale im Karton	Blisterschale im Karton
	VE: 448 Stück	VE: 770 Stück
	MBM: 448 Stück	MBM: 770 Stück

Weitere Details siehe Anhang.

Geplante Einführung: 1. Dezember, 2021
Geplante erste Auslieferungen: 1. Dezember, 2021

Anlage PCN (ID-Nr. MAG-693300721)
Details zur bisherigen und neuen Verpackung

Kontakt Jessan Zhong, MAG TF T PM, Hongqi

Kunden wenden sich bei Fragen bitte direkt an ihren Ansprechpartner im Vertrieb.

TDK Elektronik AG

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Induktivitäten
Intern / Extern

210820IN1g

Product / Process Change Notification

1. ID No. MAG-693300721		2. Date of announcement August 20, 2021	
3. Product / product group Frame core chokes	Old ordering code B82732F*	New ordering code No Change	Customer part number n.a.
4. Description of change Packaging will be changed from polystyren tray to blister tray. The number of products per packing unit will be increased as follows: B82732F* from 448 to 770 pcs. Consequently the minimum order quantity will also be changed accordingly (see annex).			
5. Effect on the product or for the customer (benefit, quality, specification, lead time) Harmonization of package for the product families. Better environmental impact as new packaging materials can be recycled			
6. Quality assurance measures / risk assessment Qualification for blister trays of this FC choke family was done.			
7. Scheduled date of change December 1, 2021			
8. Estimated date of first delivery of changed product December 1, 2021 If TDK Electronics AG does not receive notification to the contrary within a period of 10 weeks, TDK Electronics AG assumes that the customer agrees to the change. <input checked="" type="checkbox"/> For an interim period we cannot rule out that old as well as new products will be shipped. <input type="checkbox"/> Future shipments can consist of old and new products as the new changed product is used as an alternative to the old product.			
Quality Management Name Wolfgang Woitsch, 2021-07-30		Signature Signed Woitsch	
Product Marketing Name Jessan Zhong Tel. +86 756 6828853 E-mail jessan.zhong@tdk-electronics.tdk.com		Signature Signed Jessan Zhong	
Customer feedback			
Customer acknowledgement		Signature	

Annex to UPtoDATE 210820IN1 of August 20, 2021 / Change of packaging of B82732F frame core chokes

Illustration of previous and new packages



Picture 1: Previous package
Polystyrene tray in cardboard box



Picture 2: New package
Blister tray in cardboard box

Part and packaging details

Series	Ordering code	Previous				New			
		Polystyrene (pcs/trays)	Trays / cardboard box	Packing unit (pcs/bcardboard box)	Cardboard box size (L*W*H)	Polystyrene (pcs/trays)	Trays / cardboard box	Packing unit (pcs/bcardboard box)	Cardboard box size (L*W*H)
B82732F*	B82732F2162B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2132B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2901B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2801B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2701B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2601B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2451B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm